ON Semiconductor®

Product Bulletin

Document #:PB23025Z
Issue Date:20 Dec 2019

Title of Change:	Change TO247 mold downset A1 remark position from lead tip to lead root for Automotive products.
Effective date:	20 Dec 2019
Contact information:	Contact your local ON Semiconductor Sales Office or Daisy.Zhi@onsemi.com
Type of notification:	This Product Bulletin is for notification purposes only. ON Semiconductor will proceed with implementation of this change upon publication of this Product Bulletin.
Change Category:	Assembly Change
Change Sub-Category(s):	Datasheet/Product Doc change

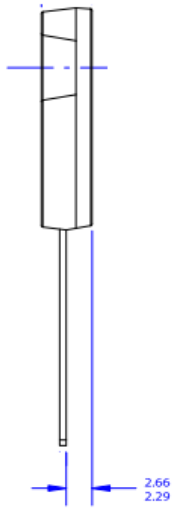
Sites Affected:

ON Semiconductor Sites	**External Foundry/Subcon Sites**
ON Semiconductor Suzhou, China	None

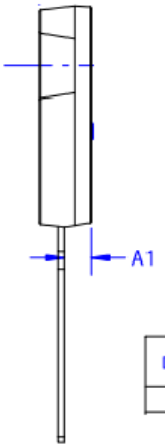
Description and Purpose:

Change A1 remark position from lead tip to lead root, value no change.
Impact MOD are: 340CD, 340CF, 340CH, 340CJ, 340CK, 340CL, 340CU, 340CW, 340CX.This to follow ON standard drawing style and eliminate the confusion from internal and external.

Example:



from



DIM	MILLIMETERS		
	MIN	NOM	MAX
A1	2.29	2.475	2.66

to

List of Affected Standard Parts:

***Note**: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.*

FFSH20120ADN-F085	FFSH2065BDN-F085	FFSH40120ADN-F085
FCH041N65F-F085	FCH077N65F-F085	FCH190N65F-F085
FGH20N60SFDTU-F085	FGH40N60SFDTU-F085	FGH40N60SMD-F085
FGH40N60SMDF-F085	FGH40N65UFDTU-F085	FGH60N60SFDTU-F085
FGH60N60SMD-F085	FGH60N60UFDTU-F085	FGH75T65UPD-F085

RHRG1560CC-F085	RURG3060CC-F085	FFH50US60S-F085
FFSH10120A-F085	FFSH20120A-F085	FFSH3065B-F085
ISL9R1560G2-F085	ISL9R3060G2-F085	RHRG1560-F085
RHRG3060-F085	RHRG5060-F085	RURG3060-F085
RURG5060-F085	RURG8060-F085	FGY160T65SPD-F085
FGY160T65SPD-F085E	FFSH1265BDN-F085	FCH041N60F-F085
FCH072N60F-F085	FCH104N60F-F085	FCH47N60-F085
FCH47N60F-F085	FGH40T65SPD-F085	RURG80100-F085
FGY120T65SPD-F085	NVHL027N65S3F	

Japanese translation of the notification starts here.

通知の日本語訳はここから始まります。

Note*: The Japanese version is for reference only. In case of any differences between the English and Japanese version, the English version shall control.*

注：日本語版は参照用です。英語版と日本語版の違いがある場合は、英語版が優先されます.

製品速報

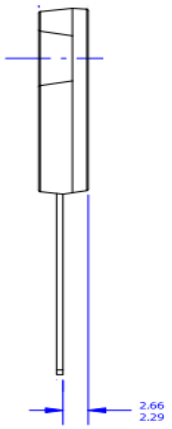
文書番号:PB23025Z
発行日:20 Dec 2019

変更件名:	車載製品の TO247 の モールドダウンセット A1 のリマーク位置をリード先端からリード付け根への変更	
発効日:	20 December 2019	
連絡先情報:	現地のオン・セミコンダクター営業所または < Daisy.Zhi @onsemi.com> にお問い合わせください。	
通知種別::	本製品速報は通知目的のみのものです。オン・セミコンダクターは本製品速報の発行により本変更を実行します。	
変更カテゴリ:	アセンブリの変更	
変更サブカテゴリ:	データシート/製品文書の変更	
影響を受ける拠点:	オン・セミコンダクター拠点: ON Semiconductor Suzhou, China	外部製造工場 / 下請業者拠点: なし

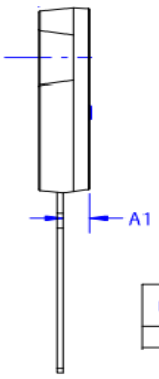
説明および目的:

A1 リマーク位置をリード先端からリード付け根に変更、数値に変更なし。
対象のケースアウトラインは、340CD、340CF、340CH、340CJ、340CK、340CL、340CU、340CW、340CX。これは、オンの標準図面スタイルに従い、社内外の混乱を避けることを目的としています。

Example:



from



DIM	MILLIMETERS		
	MIN	NOM	MAX
A1	2.29	2.475	2.66

to

影響を受ける部品の一覧:

注: 標準の部品番号(既製品)のみが部品一覧に記載されます。 本 PCN に影響を受けるカスタム 部品は、PCN メールの顧客の特定の PCN の付属文書、または PCN カスタマイズポータルに記載されています。

FFSH20120ADN-F085	FFSH2065BDN-F085	FFSH40120ADN-F085
FCH041N65F-F085	FCH077N65F-F085	FCH190N65F-F085
FGH20N60SFDTU-F085	FGH40N60SFDTU-F085	FGH40N60SMD-F085
FGH40N60SMDF-F085	FGH40N65UFDTU-F085	FGH60N60SFDTU-F085
FGH60N60SMD-F085	FGH60N60UFDTU-F085	FGH75T65UPD-F085
RHRG1560CC-F085	RURG3060CC-F085	FFH50US60S-F085

FFSH10120A-F085	FFSH20120A-F085	FFSH3065B-F085
ISL9R1560G2-F085	ISL9R3060G2-F085	RHRG1560-F085
RHRG3060-F085	RHRG5060-F085	RURG3060-F085
RURG5060-F085	RURG8060-F085	FGY160T65SPD-F085
FGY160T65SPD-F085E	FFSH1265BDN-F085	FCH041N60F-F085
FCH072N60F-F085	FCH104N60F-F085	FCH47N60-F085
FCH47N60F-F085	FGH40T65SPD-F085	RURG80100-F085
FGY120T65SPD-F085	NVHL027N65S3F	